

isc N-Channel MOSFET Transistor

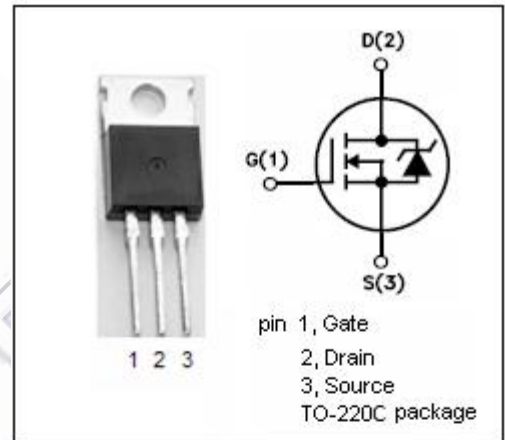
STP180N10F3

DESCRIPTION

- Ultra low on-resistance
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

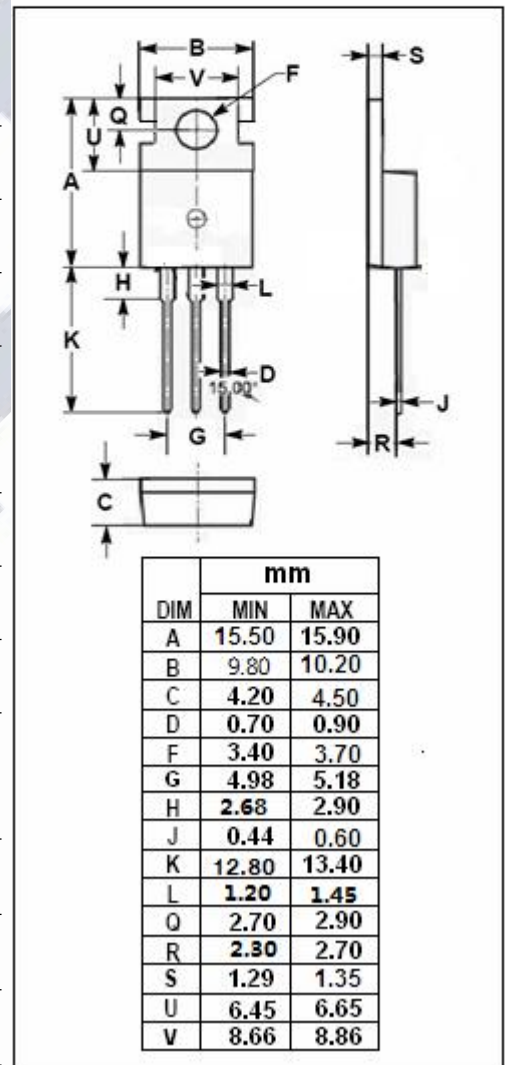
APPLICATIONS

- Designed for high current switching applications



ABSOLUTE MAXIMUM RATINGS(T_a=25°C)

SYMBOL	PARAMETER	VALUE	UNIT
V _{DSS}	Drain-Source Voltage (V _{GS} =0)	100	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current-continuous@ TC=25°C	120	A
	Drain Current-continuous@ TC=100°C	120	
I _{DM}	Drain Current-Single Pulsed	480	A
P _{tot}	Total Dissipation@TC=25°C	315	W
T _{stg}	Storage Temperature Range	-55~150	°C



THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
R _{th j-c}	Thermal Resistance,Junction to Case	0.48	°C/W
R _{th j-a}	Thermal Resistance,Junction to Ambient	62.5	°C/W

isc N-Channel Mosfet Transistor**STP180N10F3****• ELECTRICAL CHARACTERISTICS (T_c=25°C)**

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0; I _D = 0.25mA	100		V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} ; I _D = 0.25mA	2	4	V
R _{DS(on)}	Drain-Source On-stage Resistance	V _{GS} =10V; I _D = 60A		4.8	mΩ
I _{GSS}	Gate Source Leakage Current	V _{GS} = ±20V; V _{DS} = 0		±200	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V; V _{GS} = 0		10	uA
V _{SD*}	Diode Forward Voltage	I _F = 120A; V _{GS} =0		1.5	V

*:pulse duration=300us,duty cycle 1.5%.